A SIMPLIFIED IMPEDANCE MODEL FOR ADHESIVELY-BONDED PIEZO-IMPEDANCE TRANSDUCERS

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ABSTRACT

The electro-mechanical impedance (EMI) technique employs surface-bonded lead zirconate titanate piezo-electric ceramic (PZT) patches as impedance transducers for structural health monitoring (SHM) and non-destructive evaluation (NDE). The patches are bonded to the monitored structures using finitely thick adhesive bond layer, which introduces shear lag effect, thus invariably influencing the electro-mechanical admittance signatures. This paper presents a new simplified impedance model to incorporate shear lag effect into electro-mechanical admittance formulations, both 1D and 2D. This provides a closed-form analytical solution of the inverse problem, i.e to derive the true structural impedance from the measured conductance and susceptance signatures, thus an improvement over the existing models. The influence of various parameters (associated with the bond layer) on admittance signatures is investigated using the proposed model and the results compared with existing models. The results show that the new

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model, which is far simpler than the existing models, models the shear lag phenomenon reasonably well besides providing direct solution of a complex inverse problem.

**CE Database Headings:** Elastic Analysis; Sensors; Shear Lag; Piezoelectricity

**Key Words:** Electro-mechanical impedance (EMI) technique; adhesive; shear lag; structural health monitoring (SHM); conductance; susceptance.
INTRODUCTION

This paper is primarily focused on development of a simplified analytical model for shear lag effect inherent in adhesively bonded PZT patches for direct use in SHM/ NDE through the EMI technique. The EMI technique, which originated over one and a half decade ago, is now very widely accepted as a cost effective and highly sensitive technique for SHM and NDE of a variety of engineering systems (Sun et al. 1995; Soh et al. 2000; Park et al. 2000; Giurgiuuiu and Zagrai 2002; Bhalla and Soh 2003; Park et al. 2006). This technique makes use of the PZT patches as impedance transducers (Bhalla and Soh 2004a, b) by utilizing their direct and converse piezoelectric properties simultaneously. The structural component to be monitored is instrumented with a PZT patch on the surface, which is excited through an alternating voltage signal using an impedance analyzer/ LCR meter, sweeping through a particular frequency range (of the order of tens to hundreds of kHz). At any particular frequency, the patch actuates the structure and the structural response is simultaneously sensed and measured by the patch in terms of electromechanical admittance, consisting of conductance (the real component), and susceptance (the imaginary component). In this manner, frequency plots, termed conductance and susceptance signatures, are generated. Any change in the condition of the structure manifests itself as a deviation in these signatures, which is utilized for SHM and NDE, considering the signatures of the healthy state structure as the baseline. Owing to the high frequency of excitations (30 - 400 kHz range), the damage sensitivity of the EMI technique is far higher than any of the conventional NDE techniques, say global vibration techniques or local NDE techniques (Park et al. 2000).
The PZT patches, which play the key role in the EMI technique, typically develop surface charges under mechanical stresses and conversely undergo mechanical deformations when subjected to electric fields, as expressed mathematically by (IEEE standard 1987)

\[ D_i = \varepsilon_{ij}^T E_j + d_{m} T_m \]  
\[ S_k = d_{jk} E_j + s_{km}^E T_m \]

where \( D_i \) is the electric displacement, \( S_k \) the mechanical strain, \( E_j \) the electric field and \( T_m \) the mechanical stress. \( \varepsilon_{ij}^T \) denotes the complex electric permittivity of the PZT material at constant stress, \( d_{m} \) and \( d_{jk} \) the piezoelectric strain coefficients (or constants) and \( s_{km}^E \) the complex elastic compliance at constant electric field. The superscripts ‘\( T \)’ and ‘\( E \)’ indicate that the quantity has been measured at constant stress and constant electric field respectively.

During the last one and half decades, several attempts have been made to model the PZT-structure electromechanical interaction. The beginning was made by Crawley and de Luis (1987) in the form of ‘static approach’, later substituted by the ‘impedance approach’ of Liang, et al. (1994). Liang and coworkers modelled the host structure as mechanical impedance \( Z_s \) connected to the PZT patch at the end, as shown in Fig. 1(a), with the patch undergoing axial vibrations under an alternating electric field \( E_3 \). Mathematically, \( Z_s \) is related to the force \( F \) and the velocity \( \dot{u} \) by

\[ F_{(x=l)} = -Z_s \dot{u}_{(x=l)} \]  

Solution of the governing 1D wave equation resulted in following expression for the complex electromechanical admittance for the system of Fig. 1(a)
\( \bar{Y} = G + Bj = \omega j \frac{wl}{h} \left[ (\varepsilon_{33} - d_{31}^2 \bar{Y}^E) + \left( \frac{Z_a}{Z_S + Z_a} \right) d_{31}^2 \bar{Y}^E \left( \frac{\tan \kappa l}{\kappa l} \right) \right] \)  \hspace{1cm} (4)

where \( w, l \) and \( h \) represent the PZT patch’s dimensions (see Fig. 1a), \( d_{31} \) the piezoelectric strain coefficient for the 1-3 axes and \( \omega \) the angular frequency. \( \bar{Y}^E = Y^E (1 + \eta j) \) is the complex Young’s modulus of the PZT patch (at constant electric field) and \( \varepsilon_{33}^E = \varepsilon_{33}^E (1 - \delta j) \) the complex electric permittivity (at constant stress), with the symbols \( \eta \) and \( \delta \) denoting the mechanical loss factor and the dielectric loss factor respectively. \( Z_a \) represents the mechanical impedance of the PZT patch (in short circuited condition), given by

\[ Z_a = \kappa \omega h \frac{\bar{Y}^E}{\tan \kappa l (j \omega)} \]  \hspace{1cm} (5)

where \( \kappa \), the wave number, is related to the density \( \rho \) and the Young’s modulus \( \bar{Y}^E \) of the patch by

\[ \kappa = \omega \sqrt{\frac{\rho}{\bar{Y}^E}} \]  \hspace{1cm} (6)

In real-life applications, where the PZT patch is surface-bonded on a structure, the nodal plane passes through the centre line of the patch, as shown in Fig. 1(b). The structure can be represented as a set of impedances \( Z_s \) connected on the either side of the patch, as illustrated in Fig. 1(c). For this scenario, \( l \) would be the half-length of the patch and Eq. (4) needs to be modified as

\[ \bar{Y} = G + Bj = 2 \omega j \frac{wl}{h} \left[ (\varepsilon_{33} - d_{31}^2 \bar{Y}^E) + \left( \frac{Z_a}{Z_S + Z_a} \right) d_{31}^2 \bar{Y}^E \left( \frac{\tan \kappa l}{\kappa l} \right) \right] \]  \hspace{1cm} (7)

Zhou et al. (1996) extended the formulations of Liang to model the a PZT element coupled to a 2D host structure. The related physical model is schematically illustrated in Fig. 2. Zhou and
coworkers replaced the single term $Z_s$ by a matrix consisting of the direct impedances $Z_{xx}$ and $Z_{yy}$, and the cross impedances $Z_{xy}$ and $Z_{yx}$, related to the planar forces $F_1$ and $F_2$ (along axes 1 and 2 respectively) and the corresponding planar velocities $\dot{u}_1$ and $\dot{u}_2$ by

$$
\begin{bmatrix}
F_1 \\
F_2 
\end{bmatrix} =
-\begin{bmatrix}
Z_{xx} & Z_{xy} \\
Z_{yx} & Z_{yy}
\end{bmatrix}
\begin{bmatrix}
\dot{u}_1 \\
\dot{u}_2
\end{bmatrix}
$$

(8)

Considering dynamic equilibrium along the two principal axes in conjunction with piezoelectric constitutive relations (Eqs. 1 and 2), they derived

$$
Y = j\omega \frac{w l}{k} \left[ E_{11} - \frac{2 d_1^2 Y^E}{(1 - \nu)} + \frac{d_2^2 Y^E}{(1 - \nu)} \left( \frac{\sin \kappa l}{l} \frac{\sin \kappa w}{w} \right) \right]
\left[ \kappa \cos(\kappa l) \left\{ 1 - \frac{w}{l} \frac{Z_{xx}}{Z_{xx} + \nu Z_{yy}} \right\} + \kappa \cos(\kappa w) \left\{ \frac{1}{w} \frac{Z_{xx}}{Z_{xx} + \nu Z_{yy}} \right\} \right]^{-1} \left[ \begin{bmatrix}
1 \\
1
\end{bmatrix} \right]
$$

(9)

where $\kappa$, the 2D wave number, is given by

$$
\kappa = \omega \sqrt{\frac{\rho(1 - \nu^2)}{Y^E}}
$$

(10)

$Z_{axx}$ and $Z_{ayy}$ are the two components of the mechanical impedance of the PZT patch along the two principal directions, given by Eq. 5. Although the analytical derivations of Zhou and coworkers are accurate in themselves, the experimental difficulties prohibit their direct application for the inverse problem, i.e. the extraction of host structure’s mechanical impedance. Using the EMI technique, one can experimentally obtain two quantities- $G$ and $B$ for a surface-bonded PZT patch. If complete information about the structure is desired, Eq. (9) needs to be solved for 4 complex unknowns- $Z_{xx}$, $Z_{yy}$, $Z_{xy}$, $Z_{yx}$ (or 8 real unknowns). Hence, the model could not be employed for the experimental determination of the drive point mechanical impedance from measurements alone.
To alleviate these shortcomings, the concept of ‘effective impedance’ was introduced by Bhalla and Soh (2004a). The related physical model is shown in Fig. 3 for a square-shaped PZT patch of half-length \( l \). Bhalla and Soh (2004a) represented the PZT-structure interaction in the form of boundary traction \( f \) per unit length, varying harmonically with time. The ‘effective mechanical impedance’, \( Z_{a,\text{eff}} \), of the patch was defined as

\[
Z_{a,\text{eff}} = \frac{F_{\text{eff}}}{u_{\text{eff}}} = \oint_S \hat{n} ds \frac{\hat{n}}{u_{\text{eff}}} = \frac{2hY^E}{j\omega(1-\nu)\bar{T}}
\]

(11)

where \( F_{\text{eff}} \) is the overall planar force (or the effective force) causing area deformation of the PZT patch and \( \hat{n} \) is the unit vector normal to the boundary. \( u_{\text{eff}} = \delta A/p_o \) is the ‘effective displacement’, with \( \delta A \) denoting the change in the patch’s area and \( p_o \) its original undeformed perimeter. Differentiation of the effective displacement with respect to time yields the effective velocity, \( \dot{u}_{\text{eff}} \). The effective drive point impedance of the host structure can be similarly defined, by applying a force on the surface of the host structure, along the boundary of the proposed location of the PZT patch. The term \( \bar{T} \) is the complex tangent ratio, theoretically equal to \( \left[ \tan(\kappa l) / \kappa l \right] \). However, in actual situations, it needs correction to realistically consider the deviation of the PZT patch from the ideal behavior, to accommodate which Bhalla and Soh (2004a) introduced correction factors as

\[
\bar{T} = \begin{cases} 
\frac{\tan(\kappa l)}{\kappa l} & \text{for single-peak behavior.} \\
\frac{1}{2} \left( \frac{\tan C_1 \kappa l}{C_1 \kappa l} + \frac{\tan C_2 \kappa l}{C_2 \kappa l} \right) & \text{for twin-peak behavior.}
\end{cases}
\]

(12)
The correction factors $C_1$ and $C_2$ (or $C$), and whether the patch conforms to ‘single-peak’ or ‘twin-peak’ behaviour, can be determined from the experimentally obtained conductance and susceptance signatures of the PZT patch in ‘free-free’ conditions before bonding it on the host structure, as outlined by Bhalla and Soh (2004a). It has been demonstrated by that this ‘updating’ enables a much more accurate results. Solution of the governing 2D wave equation for this system yielded following expression for the complex electro-mechanical admittance $\tilde{Y}$

$$\tilde{Y} = G + Bj = 4\omega \frac{j}{h} t^2 \left[ \frac{2d_s^2 Y^E}{\epsilon_{33}^T} - \frac{2d_s^2 Y^E}{(1-\nu)} + \frac{Z_{a,eff}}{(Z_{s,eff} + Z_{a,eff})} \right]$$

Here, a single complex term for $Z_{s,eff}$ (rather than four terms as in Zhou’s model) accounts for the 2D mechanical interaction of the patch with the host structure. This makes the resulting equation simple enough to solve the inverse problem, i.e. to extract $Z_{s,eff}$ (Bhalla and Soh, 2004b), to be directly utilized for SHM/ NDE. No modelling is required for the host structure and the necessary data is directly obtainable from experimental measurements.

Annamdas and Soh (2007a) extended the 2D modeling to 3D, especially keeping in view thick PZT patches, by proposing a directional sum impedance model, taking into account the PZT patch’s vibrations along all the three directions. They defined the directional sum impedance as

$$Z_s = -(Z_{s1} + Z_{s2}) + Z_{s3} - 2Z_{12} + 2Z_{23} + 2Z_{31}$$

where the individual normal impedances ($Z_{s1}$, $Z_{s2}$, $Z_{s3}$) and the cross impedances ($Z_{12}$, $Z_{23}$, $Z_{31}$) are defined by Eqs.(15) and (16) respectively as

$$Z_{si} = \frac{F_i}{u_i} \quad (15)$$
\[ Z_g = -\frac{Z_S Z_s}{Z_s + Z_g - Z_S} \]  

(16)

The above definition resulted in a very set of complicated differential equations with no closed-form solution. As a simplification, the shear stress equation was ignored and the constants of integration proposed to be obtained through finite element analysis, thereby necessitating modelling of the structure concerned. The PZT patch also needs to be included in the model. Thus, the directional sum impedance approach could not be independently used with experimental data alone for solving the inverse problem.

In general, all the above models ignore the fact that the mechanical interaction between the PZT patch and the host structure occurs through a finitely thick layer of adhesive which, introduces the so-called ‘shear lag effect’ through its elastic deformation. This paper reviews the existing analytical approaches which model this aspect and proposes a new simplified model which is especially suitable for solving the inverse problem (of extracting \( Z_s \)), considering the presence of bond layer, in conjunction with the EMI technique. The main advantage over the previous models is that a closed-form analytical solution is derived which can be used directly with the measured \( G \) and \( B \) values, without necessitating any modelling for the host structure, bond layer or the PZT patch.

**SHEAR LAG EFFECT**

Fig. 4 illustrates the mechanism of physical deformation occurring in the PZT patch, the bond layer and the host structure for an adhesively-bonded PZT patch. Since force transmission occurs through the shearing of the bond layer, the displacement \( u \) (and hence strain) on the surface of the host structure is different from the displacement \( u_p \) (and hence strain) in the patch above.
This phenomenon is called the ‘shear lag effect’. For the special case of a PZT patch bonded on a beam surface, and acting as a sensor, Sirohi and Chopra (2000) derived following expression for the strain ratio \(S_p/S_b\) (PZT strain to beam surface strain)

\[
\frac{S_p}{S_b} = \left[ 1 - \frac{\cosh(\Gamma x)}{\cosh(\Gamma l)} \right]
\]

where \(\Gamma\) is the shear lag parameter, given by

\[
\Gamma = \sqrt{\frac{G_S}{Y^E h_p h_p} + \frac{3G_s w_p}{Y_b h_b h_p}}
\]

where \(h_p\) and \(h_S\) respectively denote the thicknesses of the patch and the bond layer, \(G_S\) the shear modulus of the bond layer, \(w_p\) and \(w_b\) respectively the widths of the patch and the beam, and \(Y^E\) and \(Y_b\) respectively the static Young’s modulus of the patch and the beam.

Similarly, for a PZT patch acting as an actuator, the strains \(S_p\) and \(S_b\) were derived by Crawley and de Luis (1987) as

\[
S_p = \frac{3\Lambda}{(3 + \psi)} + \frac{\Lambda \psi \cosh \Gamma x}{(3 + \psi) \cosh \Gamma l} \quad \text{and} \quad S_b = \frac{3\Lambda}{(3 + \psi)} - \frac{3\Lambda \cosh \Gamma x}{(3 + \psi) \cosh \Gamma l}
\]

where \(\Lambda = d_{31}E_s\) is the free piezoelectric strain, and \(\psi = Y_b h_b / Y^E h_p\).

Integration of the shear lag effect into impedance modelling, especially for the EMI technique, was first attempted by Xu and Liu (2002). They included the bond layer in Liang’s 1D impedance model by considering it as a single degree of freedom system connected in between the PZT patch and the impedance \(Z_s\) (of the host structure). The resultant equivalent impedance of the combination was determined as
\[
Z_{eq} = \left[ \frac{K_b}{K_b + K_S} \right] Z_S
\]

(20)

where \( K_b \) represents the dynamic stiffness of the bond layer and \( K_S \) that of the structure. The effort, however, was incomplete, as no expression for \( K_b \) was derived. Ong et al. (2002) included the effect of the bond layer by considering strain variation as given by Eq. (17). This included the ‘sensor effect’, but invariably ignored the associated ‘actuator effect’. In addition, the solution was restricted to beam structures only.

Bhalla and Soh (2004c) derived generalized formulations for electro-mechanical admittance across an adhesively bonded square PZT patch. By rigorously considering the deformation pattern shown in Fig. 4, following differential equation was derived for the 1D case

\[
u'''' + pu'' - qu'' = 0
\]

(21)

where \( u \) is the displacement on the surface of the host structure, below the PZT patch, and \( \bar{p} \) and \( q \) the shear lag constants, given by

\[
\bar{p} = -\frac{w_p G_s}{Z_S h_S j \omega}
\]

(22)

and

\[
q = \frac{G_s}{Y_E h_S h_p}
\]

(23)

Solving Eq. (21), the resultant mechanical impedance, called the ‘equivalent impedance’, was derived as

\[
Z_{S,eq} = \frac{Z_S}{1 + \frac{u_0'}{\bar{p} u_0}}
\]

(24)

where \( u_0 \) is the displacement at the end of the PZT patch \( (x = l) \), to be determined from,
\[ u = A_1 + A_2 e^{\lambda_3 x} + Be^{\lambda_4 x} \]  

(25)

with

\[ \lambda_3 = \frac{-p + \sqrt{p^2 + 4q}}{2} \quad \text{and} \quad \lambda_4 = \frac{-p - \sqrt{p^2 + 4q}}{2} \]  

(26)

The 1D approach was also extended to 2D effective impedance model and verified experimentally. This model was not only more rigorous but at the same time generic in nature. A parametric study revealed that to achieve best results, the adhesive layer should possess high shear modulus and minimum practicable thickness. A related experimental study has been reported by Qing et al. (2006). However, shortcoming of this model is visible for solving the inverse problem for NDE. In the damage quantification approach postulated by Bhalla and Soh (2004b), one needs to extract the mechanical impedance of the host structure \((Z_s = x + yj)\) from the measured admittance signature. In the presence of the adhesive layer, this would be \(Z_{s, eq}\), from which it is computationally very difficult to obtain the true structural impedance \(Z_s\), as clearly evident from Eqs. (21) to (26).

Annamdas and Soh (2007b) also extended their earlier formulations (2007a) for the case of an adhesive layer. However, no closed-form solution was derived. The adhesive layer needs to be included in the finite element model along with the host structure and the PZT patch. As with the earlier model of Annamdas and Soh (2007a), the approach is not able to solve the inverse problem with the measurement of \(G\) and \(B\) alone.

This difficulty of solving the inverse problem taking due consideration of the adhesive bond layer is very well alleviated by the simplified impedance model proposed in this paper. In the
next sections, the model is first derived for 1D case and then extended to 2D situations.

**NEW SIMPLIFIED 1 D IMPEDANCE MODEL**

Fig.5 shows the physical aspects of the proposed simplified 1D impedance model. The PZT patch has length 2l with zero displacement at the mid point, which is the nodal point. Hence, only right half of the system is modelled here. The bond layer is assumed to be connected in between the PZT patch and the host structure such that it can transfer the force between the two through pure shear mechanism. Unlike the previous model of Bhalla and Soh (2004c), where shear strain varied along the patch, an average shear strain uniform along the length has been considered a simplification. Let \( u_p \) be the displacement at the tip of the PZT patch at any point of time. Due to the shearing of the bond layer, same displacement would not be transferred to the host structure. Let \( u \) be the displacement of the host structure at a point just underneath the tip of the PZT patch. Let \( h_p \) and \( h_S \) respectively denote the thickness of the patch and the bond layer. Shear strain in the bond layer is given by

\[
\gamma = \frac{u_p - u}{h_s} \quad (27)
\]

which can be rearranged as,

\[
u = u_p - \left( \frac{\tau}{G_s} \right) h_s \quad (28)
\]

where \( \tau \) denotes the interfacial shear stress and \( \overline{G_S} \) the complex shear modulus of the bond layer. It should be noted that \( \overline{G_S} = G_s (1 + \eta' j) \), where \( G_s \) is the static shear modulus and \( \eta' \) the associated mechanical loss factor of the bond layer. \( \eta' \) is strongly dependent on temperature and
can typically vary from 5% to 30% at room temperature, depending on the type of adhesive
(Adams and Wake 1984). If \( F \) be the force transmitted to the host structure over the area \( A \) of
one-half of the patch, Eq. (28) can be rewritten as

\[
\frac{F}{AG_s} \frac{1}{h_s} \quad \text{(29)}
\]

Further, in terms of the structural impedance \( Z_s \), the force transmitted to the host structure can be
expressed as (Eq. 3)

\[
F = -Z_s u = -Z_s u j \omega \quad \text{(30)}
\]

Substituting \( u \) from Eq. (29) and simplifying, we get

\[
F = -Z_s j \omega \left( u_p - \frac{F h_s}{AG_s} \right) \quad \text{(31)}
\]

By rearranging the terms and with \( A = w l \), Eq. (31) can be simplified as

\[
F = -\frac{Z_s}{j \omega} \left( u_p - \frac{F h_s}{AG_s} \right) \quad \text{(32)}
\]

This can be expressed in a format similar to Eq. (30) as

\[
F = -Z_{s,\text{eq}} j \omega u_p \quad \text{(33)}
\]

where

\[
Z_{s,\text{eq}} = \frac{Z_s}{1 - \frac{Z_s \omega h_s}{w l G_s}} \quad \text{(34)}
\]

is the ‘equivalent impedance’, apparent at the ends of the PZT patch, taking into consideration
the shear lag phenomenon associated with the bond layer. Replacing \( Z_s \) by \( Z_{s,\text{eq}} \) in Eq. (7), the
modified expression for admittance across the PZT patch results as
\[
\bar{Y} = G + Bj = 2\omega j \frac{wl}{h} \left[ (\varepsilon^{T}_{33} - d_{31}^2 \bar{Y}^E) + \left( \frac{Z_\kappa}{Z_{s,eq} + Z_\kappa} \right) d_{31}^2 \bar{Y}^E \left( \frac{\tan \kappa d}{\kappa d} \right) \right]
\]

(35)

EXTENSION TO 2 D EFFECTIVE IMPEDANCE BASED IMPEDANCE MODEL

This section extends the 1D shear lag based impedance formulations derived above to 2D effective impedance-based electromechanical model proposed by Bhalla and Soh (2004a). The PZT patch is assumed to be square in shape with a half-length equal to \( l \). The strain distribution and the associated shear lag are determined along each principal direction independently, invariably introducing discontinuity at the corners, which is ignored. By applying Eq. (29) along each principal direction for the configuration of Fig. 3b (for a quarter of the patch),

\[
u_1 = u_{p1} - \left( \frac{F_1}{l^2 G_s} \right) h_s
\]

and

\[
u_2 = u_{p2} - \left( \frac{F_2}{l^2 G_s} \right) h_s
\]

(36)

(37)

where \( F_1 \) and \( F_2 \) are the forces along each direction as shown in Fig. 3(b). Adding Eqs. (36) and (37) and dividing by 2, we get

\[
\frac{u_1 + u_2}{2} = \frac{u_{p1} + u_{p2}}{2} - \left( \frac{F_1 + F_2}{2l^2 G_s} \right) h_s
\]

(38)

From the definition of effective displacement (Bhalla and Soh, 2004a)

\[
u_{\text{eff}} = \frac{\partial A}{P_o} = \frac{u_1 l + u_2 l + u_1 u_2}{2l} \approx \frac{u_1 + u_2}{2}
\]

(39)

Further, from Eq. (11),

\[
F_{\text{eff}} = F_1 + F_2
\]

(40)

Thus, using Eqs. (39) and (40), Eq. (38) can be reduced to
\[ u_{\text{eff}} = u_{p,\text{eff}} - \left( \frac{F_{\text{eff}}}{2l^2 G_s} \right) h_s \] (41)

From the definition of effective impedance,

\[ F_{\text{eff}} = -Z_{\text{eff}} u_{\text{eff}} j \omega \] (42)

Substituting Eq. (41) into (42) and solving, as for the 1D case, an expression for the equivalent effective impedance can be derived as

\[ Z_{s,\text{eff},eq} = \frac{Z_{s,\text{eff}}}{1 - \frac{Z_{s,\text{eff}} \omega h_s j}{2l^2 G_s}} \] (43)

With the above result, Eq. (13) can be modified, by replacing \( Z_{\text{eff}} \) by \( Z_{s,\text{eff},eq} \) as

\[ \bar{Y} = G + Bj = 4\omega \ j \frac{l^2}{h} \left[ \frac{C_{33}^T}{(1 - \nu)} + \frac{2d_{31}^2 \bar{Y}_E}{(1 - \nu)} \left( \frac{Z_{a,\text{eff}}}{Z_{s,\text{eff},eq} + Z_{a,\text{eff}}} \right) \bar{T} \right] \] (44)

In order to verify the proposed new model, an aluminium block, 48x48x10mm in size, was considered as the host structure. A PZT patch, 10x10x0.3mm in size, was assumed to be surface-bonded on this structure. Fig. 6 shows the 3D finite element model of a quarter of the host structure. The effective drive point impedance of the host structure was computed by carrying out 3D dynamic harmonic analysis, as outlined by Bhalla and Soh (2004a). The PZT patch or the bond layer need not be meshed since their stiffness, mass and damping are separately considered in the formulations. The physical properties of Al 6061-T6 were considered as: Young’s modulus = 68.95GPa, density = 2715 kg/m\(^3\) and Poisson’s ratio = 0.33. Rayleigh damping was considered with \( \alpha = 0 \) and \( \beta = 3 \times 10^{-9} \). Wavelength analysis and convergence test on this model has already been reported by Bhalla and Soh (2004a). A uniformly distributed planar harmonic force was applied along the boundary of the PZT patch and the displacement response was
obtained by full dynamic harmonic analysis to determine the effective drive point impedance of the structure as

\[ Z_{s,\text{eff}} = \frac{F_{\text{eff}}}{j\omega u_{\text{eff}}} \]  

(45)

Final values for \( G \) and \( B \) were determined in the frequency range 0-250kHz using Eq. (44). A 0.150mm thick epoxy layer was considered with shear modulus of \( G_s = 1 \) GPa and a mechanical loss factor of \( \eta' = 10\% \). The parameters of the PZT patch considered are listed in Table 1.

Fig. 7 shows a comparison of the variation of conductance with frequency obtained using the present model and also the previous model of Bhalla and Soh (2004c). Curves obtained by both models are plotted alongside the curves for the case of perfect bonding for comparison. The proposed simplified model predicts the conductance in consistency with the results of Bhalla and Soh (2004c). Both the models predict that the peaks tend to diminish down due to the presence of the bond layer. Similarly, Fig. 8 shows a comparison of the variation of susceptance for three cases- no bond layer, Bhalla and Soh (2004c) model and the proposed simplified model. It is observed that like the previous model, the new simplified model leads to the observation that peaks lose their sharpness and the average slope of the susceptance curve tends to reduce owing to the shear lag effect. However, the susceptance curve resulting from the present model lies intermediate of the two cases i.e perfect bond and the model of Bhalla and Soh (2004c).

The influence of important parameters on the conductance and susceptance signatures was studied using the new simplified model and the observations compared with the previous model. Fig. 9 shows the influence of the bond layer’s shear modulus on conductance signatures. Three values of \( G_s = 1.0 \) GPa, 0.5 GPa and 0.05 GPa were considered for a bond layer thickness of
0.15mm. It is observed that as $G_s$ decreases, peaks of the conductance plot subside down. Worst effect is observed for the case $G = 0.05 \text{GPa}$, for which the PZT patch behaves independent of the host structure. Fig. 10 similarly shows the influence of $G_s$ on susceptance, for which case the average slope of the curve decreases in addition to the peaks subsiding down. For $G_S = 0.05 \text{GPa}$, again the patch seems to behave independent of the structure. Similar observations were reported by Bhalla and Soh (2004c). Fig. 11 shows the influence of bond layer thickness on conductance, by considering two values $h_s = 0.1 \text{mm} \ (h_s/h_p = 0.33)$ and $0.150 \text{mm} \ (h_s/h_p = 0.5)$. It is observed that with increase of the bond layer’s thickness, the peaks subside down (notice peaks marked P₁ and P₂ in Fig. 11). Fig. 12 shows the corresponding curves for susceptance, for which it is observed that the peaks as well as the average slope of the curve subside down. The effect of increase in bond layer’s thickness is thus similar to that of reduction of $G_s$. Fig. 13 shows the influence of bond layer’s damping, for three values of $\eta' =5\%, \ 10\% \ and \ 15\%$ for a constant $G_s = 1 \text{GPa}$ and bond layer thickness of $0.150\text{mm}$. It is observed that this factor has small influence on conductance, where the average slope of the curve appears to slightly reduce but virtually no effect on susceptance signatures, an observation matching with Bhalla and Soh (2004c).

**PRACTICAL RELEVANCE OF NEW MODEL**

The results presented in the previous section show that in spite of its simplicity, the new model produces results, comparable to the previous model of Bhalla and Soh (2004c) that was analytically far more complicated. The main strength of the new shear lag model is the simplicity of application for solving the inverse problem. As pointed out above, it is computationally very difficult to obtain the true structural impedance $Z_{s,eff}$ from $Z_{s,eff,eq}$, using the
previous model for adhesively bonded PZT patches. On the other hand, using the new simplified model, the true structural impedance can be directly determined, from Eq. (43) as,

$$Z_{s,\text{eff}} = \frac{2l^2 G_s Z_{s,\text{eff,eq}}}{2l^2 G_s + Z_{s,\text{eff,eq}} \omega h_s j}$$

(46)

$Z_{s,\text{eff,eq}}$ can be obtained from the measured $G$ and $B$ directly using the equations derived by Bhalla and Soh (2004c) for use in Eq. (46) above. No modelling is required for the host structure or the bond layer The finite element modelling done in the previous section was solely for model verification purpose only and not required in the actual applications where $G$ and $B$ will be available through measurement. The true structural mechanical impedance can be conveniently used for SHM of structural and aerospace components using the method proposed by Bhalla and Soh (2004 b).

Fig. 14 compares the extracted structural impedance for an aluminium block 48x48x10mm, with and without considering the bond layer. $Z_{s,\text{eff,eq}}$ is derived from the experimentally obtained admittance signatures (Bhalla and Soh, 2004a, b) followed by $Z_{s,\text{eff}}$ using Eq. (46). It is observed that the ignoring the bond layer tends to overestimate the structural true impedance. This is because the bond layer offers additional impedance on account of its own stiffness, damping and inertia. Solving the inverse problem assuming perfect bond results into impedance “apparent ” at the patch ends, i.e with bond layer included . On the other hand, using the proposed formulations eliminates the effect of the bond layer and hence the impedance gets reduced. To determine the true impedance using the previous model would have demanded solving 4th order differential equation, which is circumvented by the new simplified model.
CONCLUSIONS

This paper has presented the development of a new simplified impedance model incorporating the shear lag effect into electro-mechanical admittance formulations. The model is first developed for 1D case and then extended to 2D case. The results of the model have been compared with those of the Bhalla and Soh’s shear lag impedance model (2004c). Further, a detailed parametric study on conductance and susceptance signatures has been carried out. Although far simplified, the proposed model is found to predict the conductance and the susceptance signatures in close proximity with those predicted by the model of Bhalla and Soh (2004c). The advantages of the new model are quite apparent. This model simplifies the complex shear lag phenomenon associated with the force transmission between the PZT patch and the host structure bonded to each other by the adhesive bond layer. It enables computing the true mechanical impedance of the structure from the measured experimental data alone, thus circumventing the necessity of preparing a model of the host structure or the bond layer.
NOTATIONS

\( C_1, C_2 \text{ (or } C) \) = Peak correction factors for PZT patch
\( d_{im} \) = Piezoelectric strain coefficient (or constant)
\( d_{3i} \) = Piezoelectric strain coefficient corresponding to x-z (or 1-3) axis
\( D_i \) = Component of electric displacement vector
\( E_j \) = Component of electric field vector
\( F_{\text{eff}} \) = Effective force
\( f \) = Boundary traction per unit length
\( \overline{G_s} \) = Complex shear modulus of elasticity of bond layer
\( h \) = Thickness
\( h_b \) = Thickness (depth) of beam
\( h_p \) = Thickness of PZT patch
\( h_S \) = Thickness of bond layer
\( \overline{K_b} \) = Dynamic stiffness of bond layer
\( \overline{K_S} \) = Dynamic stiffness of structure
\( l \) = Half-length
\( \hat{n} \) = Unit vector normal to the boundary
\( p_o \) = Perimeter of PZT patch in the undeformed condition
\( \overline{p}, q \) = Shear lag parameters for 1D model of Bhalla and Soh (2004c)
\( \overline{p}_{\text{eff}}, q_{\text{eff}} \) = Shear lag parameters for 2D model of Bhalla and Soh (2004c)
$S_k$ = Component of mechanical strain tensor

$S_1$ = Strain along axis 1.

$S_b$ = Surface strain on beam

$S_p$ = Axial strain in PZT patch

$\bar{T}$ = Complex tangent ratio

$T_m$ = Component of mechanical stress tensor

$s_{km}^E$ = Component of elastic compliance tensor at constant electric field

$u_1, u_2$ = Edge displacements of host structure along principal directions

$u_{p1}, u_{p2}$ = Edge displacements of PZT patch along principal directions

$u_{p, eff}$ = Effective displacement of PZT patch

$u_{eff}$ = Effective displacement of host structure

$w$ = Width

$w_b$ = Width of beam

$w_p$ = Width of PZT patch

$\bar{Y}$ = Complex electrical admittance

$Y^E$ = Complex Young’s modulus of PZT patch at constant electric field

$Y_b$ = Static Young’s modulus of elasticity of the beam

$Z_s$ = Structural mechanical impedance (1D case)

$Z_a$ = Mechanical impedance of the PZT patch (1D case)

$Z_{s, eq}$ = Equivalent structural mechanical impedance including shear lag effect

(1D case)
\( Z_{s,\text{eff}} \) = Effective mechanical impedance of structure (2D case)

\( Z_{a,\text{eff}} \) = Effective mechanical impedance of patch (2D case)

\( Z_{s,\text{eff,eq}} \) = Equivalent effective mechanical impedance of structure including shear lag effect (2D case)

\( \overline{\varepsilon}_{ij}' \) = Component of complex electric permittivity tensor of PZT material at constant stress along axis 3

\( \overline{\varepsilon}_{33}' \) = Complex electric permittivity of the PZT material at constant stress along axis 3

\( \eta \) = Mechanical loss factor of PZT patch

\( \eta' \) = Mechanical loss factor of bond layer

\( \delta \) = Dielectric loss factor of PZT patch

\( \psi \) = \( \frac{Y_b h_b}{Y' h_p} \), product of modulus and thickness ratios of beam and PZT patch

\( \Lambda \) = Free piezoelectric strain (= \( d_{31} E_3 \))

\( \omega \) = Angular frequency

\( \tau \) = Interfacial shear stress

\( \Gamma \) = Shear lag parameter

\( \gamma \) = Shear strain in bond layer

\( \kappa \) = Wave number

\( \delta A \) = Change in the surface area of PZT patch
REFERENCES


Conference on Smart Structures and Materials, San Diego, California, Feb.27-Mar1, 2443, 236-247.


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Table 1 Parameters of PZT patches considered.

<table>
<thead>
<tr>
<th>Physical Parameter</th>
<th>Value</th>
</tr>
</thead>
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<tr>
<td>Electric Permittivity, $\varepsilon_{33}^T$ (Farad/m)</td>
<td>$1.7785 \times 10^{-8}$</td>
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<tr>
<td>Peak correction factor, $C_f$</td>
<td>0.898</td>
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<tr>
<td>$K = \frac{2d_{31}^2Y^E}{(1-\nu)}$ (N/V²)</td>
<td>$5.35 \times 10^{-9}$</td>
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<tr>
<td>Mechanical loss factor, $\eta$</td>
<td>0.0325</td>
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<tr>
<td>Dielectric loss factor, $\delta$</td>
<td>0.0224</td>
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